

## ASS56LAF-HF

Reverse Voltage: 60V

Forward Current: 5A

RoHS Device

Halogen Free

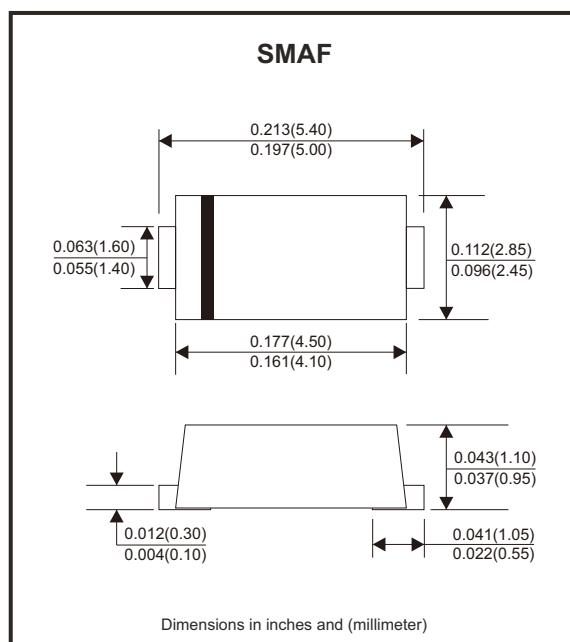


### Features

- Metal silicon junction, majority carrier conduction.
- High forward surge current capability.
- Low forward voltage drop.
- High temperature soldering guaranteed:  
260°C @ 10s.
- Robust guarding for over voltage protection.
- AEC-Q101 Qualified.

### Mechanical data

- Case: SMAF, molded plastic.
- Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD22-B102.
- Polarity: Color band denotes cathode end.
- Mounting position: Any.



### Circuit Diagram



### Maximum Ratings (at TA=25°C, unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak repetitive reverse voltage	V <sub>RRM</sub>	60	V
RMS reverse voltage	V <sub>RMS</sub>	42	V
DC blocking voltage	V <sub>DC</sub>	60	V
Average forward output current	I <sub>o</sub>	5	A
Peak forward surge current, 8.3ms single half sine-wave	I <sub>FSM</sub>	150	A
Operating junction temperature range	T <sub>J</sub>	-55 to +150	°C
Storage temperature range	T <sub>STG</sub>	-55 to +150	°C

### Thermal Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit
Typical thermal resistance (Note 1)	R <sub>θJA</sub>		78		°C/W
	R <sub>θJC</sub>		18		
	R <sub>θJL</sub>		20		

Notes: 1. Device mounted on PCB with 10mm x 20mm x 0.1mm copper pad areas.

## Electrical Characteristics (at $T_A=25^\circ\text{C}$ , unless otherwise noted)

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Instantaneous forward voltage (Note 1)	$I_F = 5\text{A}$ , @ $T_A = 25^\circ\text{C}$	$V_F$			0.65	V
Reverse current (Note 2)	Rated $V_R$ , @ $T_J = 25^\circ\text{C}$ @ $T_J = 100^\circ\text{C}$	$I_R$			100	$\mu\text{A}$
					10	mA

Notes: 1. Pulse test: 300 $\mu\text{s}$  pulse width, 1% duty cycle.

2. Pulse test: pulse width 40ms.

## Typical Rating and Characteristics Curves (ASS56LAF-HF)

Fig.1 - Forward Current Derating Curve

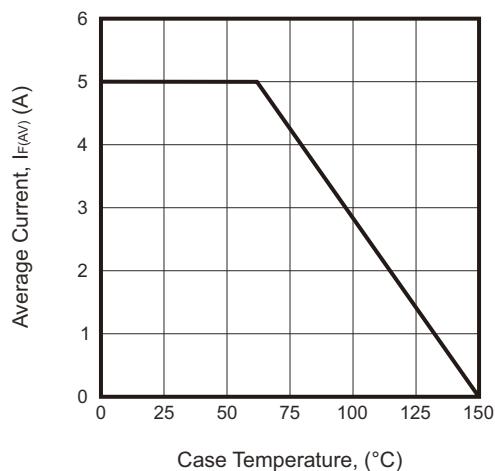


Fig.2 - Surge Current Derating Curve

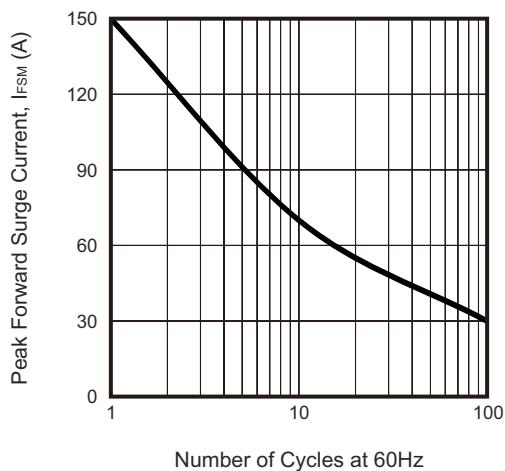


Fig.3 - Typical Forward Voltage Characteristics

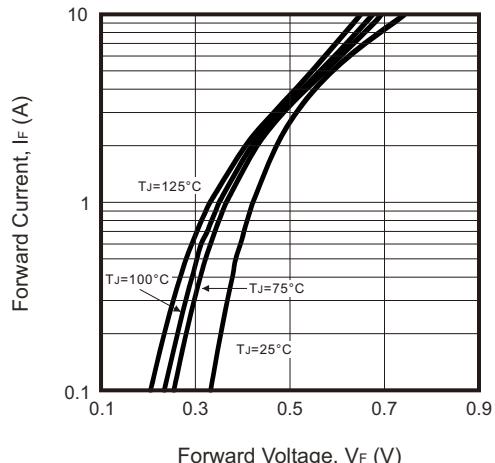
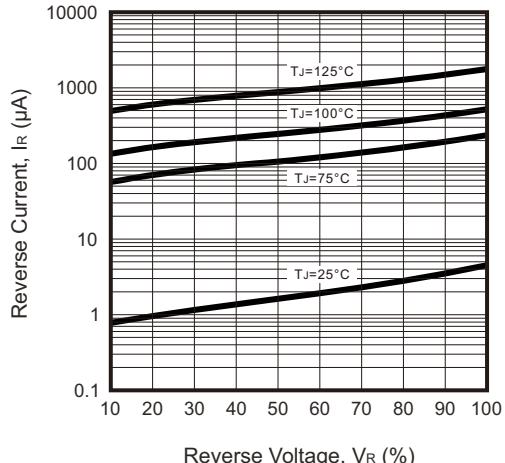
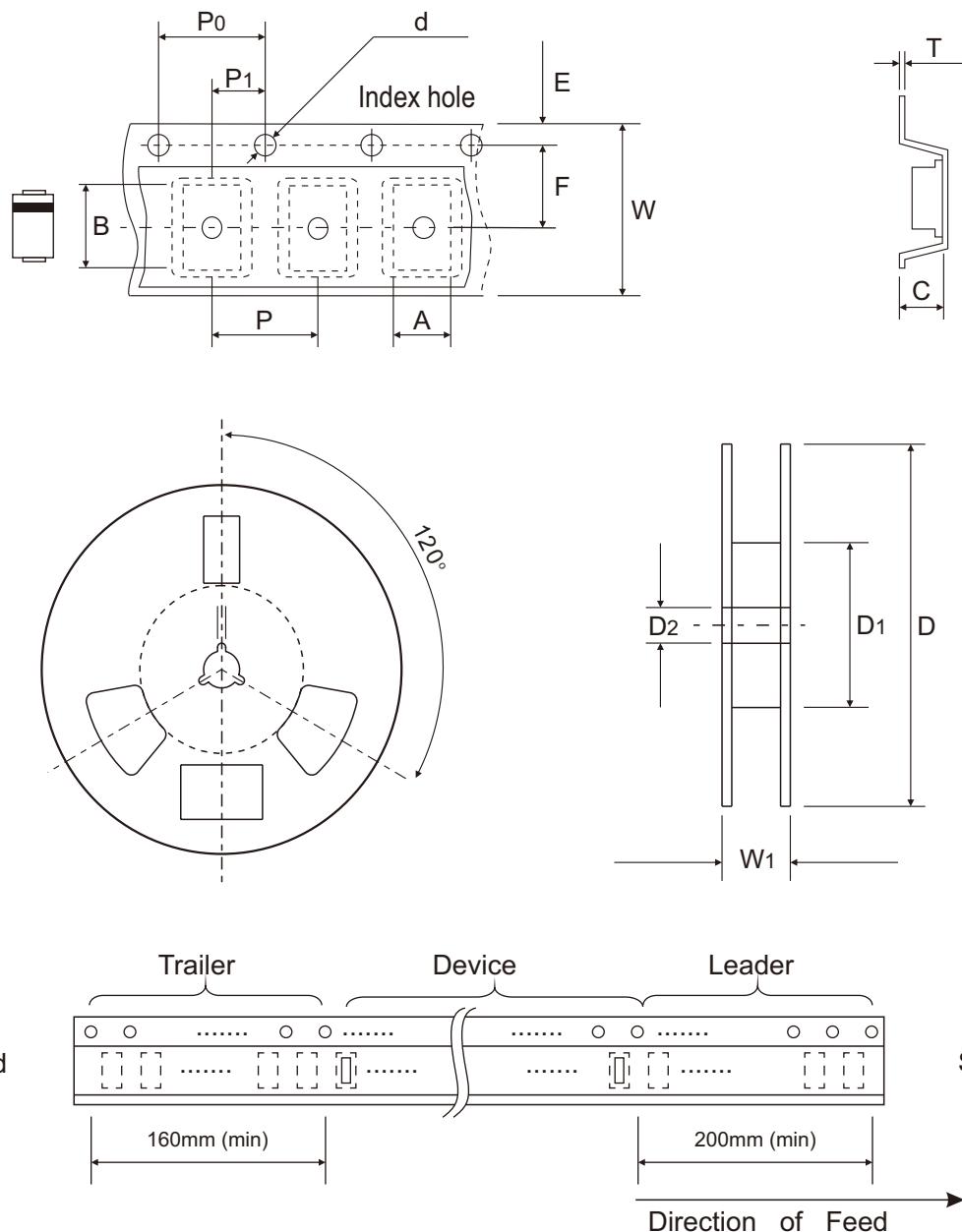


Fig.4 - Typical Reverse Characteristics



## Reel Taping Specification

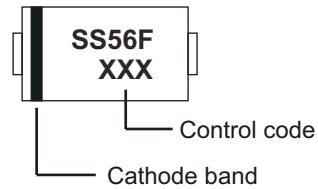


SMAF	SYMBOL	A	B	C	d	D	D1	D2
	(mm)	$2.93 \pm 0.10$	$5.45 \pm 0.10$	$1.10 \pm 0.10$	$1.55 \pm 0.10$	$330.00 \pm 1.00$	$75.00 \pm 1.00$	$13.50 \pm 0.50$
	(inch)	$0.115 \pm 0.004$	$0.215 \pm 0.004$	$0.043 \pm 0.004$	$0.061 \pm 0.004$	$12.992 \pm 0.039$	$2.953 \pm 0.039$	$0.531 \pm 0.020$

SMAF	SYMBOL	E	F	P	P0	P1	T	W	W1
	(mm)	$1.75 \pm 0.10$	$5.50 \pm 0.05$	$4.00 \pm 0.10$	$4.00 \pm 0.10$	$2.00 \pm 0.10$	$0.23 \pm 0.05$	$12.00 \pm 0.10$	$18.10 \pm 0.50$
	(inch)	$0.069 \pm 0.004$	$0.217 \pm 0.002$	$0.157 \pm 0.004$	$0.157 \pm 0.004$	$0.079 \pm 0.004$	$0.009 \pm 0.002$	$0.472 \pm 0.004$	$0.713 \pm 0.020$

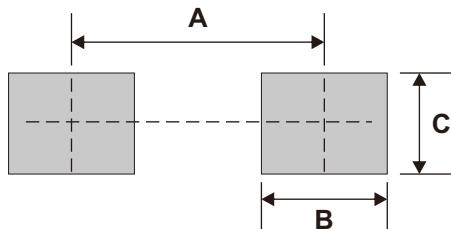
## Marking Code

Part Number	Marking Code
ASS56LAF-HF	SS56F



## Suggested P.C.B. PAD Layout

SIZE	SMAF	
	(mm)	(inch)
A	4.18	0.165
B	2.08	0.082
C	1.67	0.066



## Standard Packaging

Case Type	REEL PACK	
	REEL ( pcs )	Reel Size (inch)
SMAF	10,000	13